

# Evaluation of charge collection efficiency of strip-type silicon sensors

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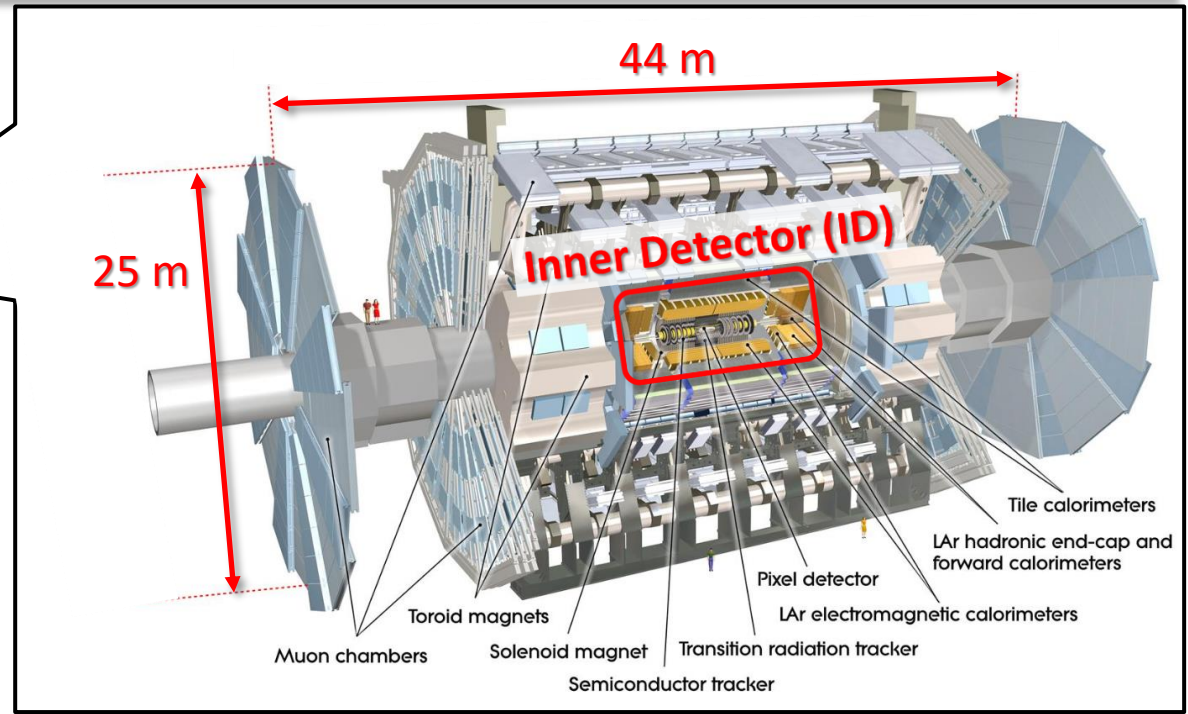
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2024 Joint Workshop of FKPPN and TYL/FJPPN

# ■ ATLAS Experiment at LHC

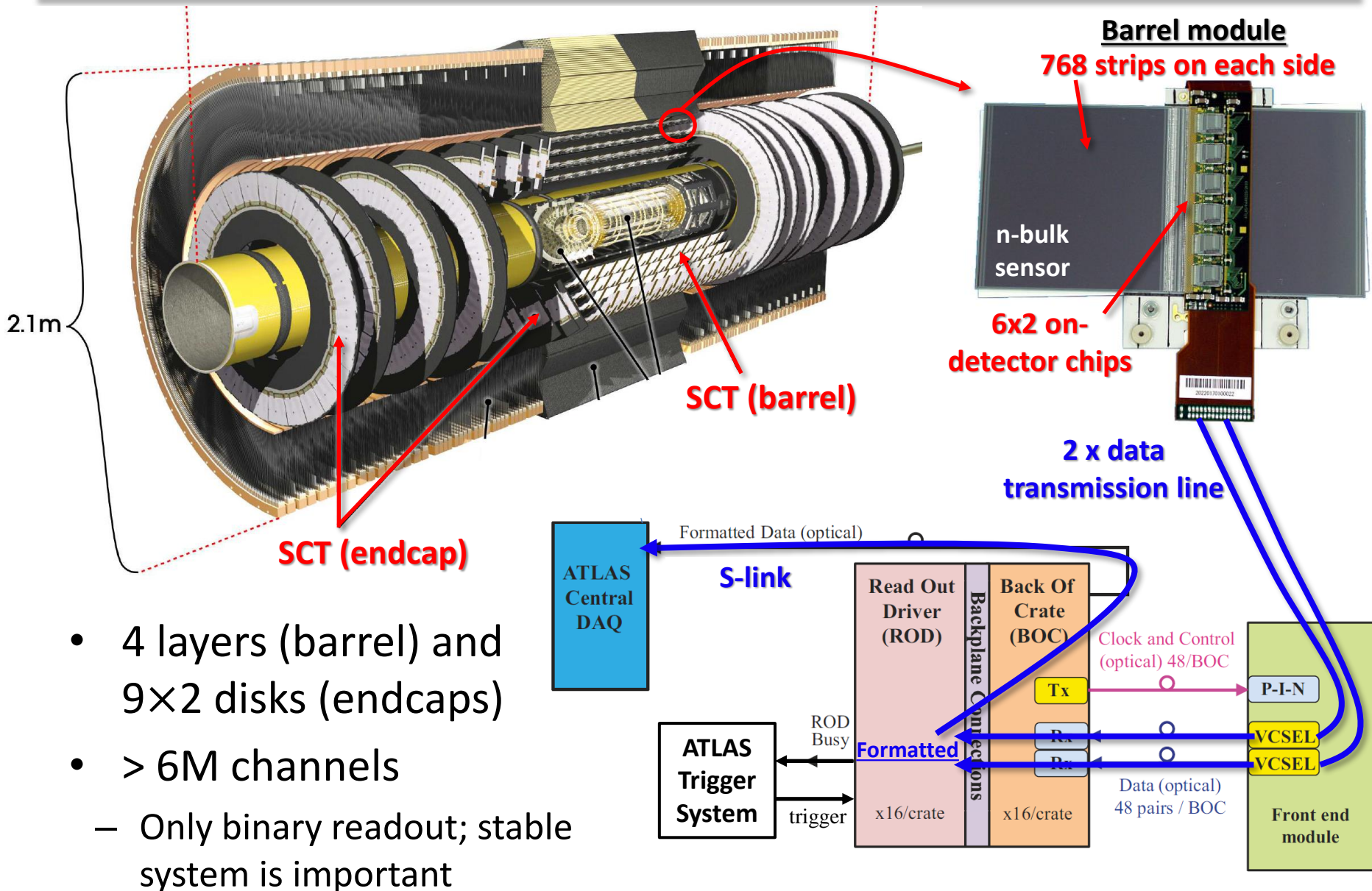


- Circumference = 27 km
- $pp$  collision at  $\sqrt{s} = 13.6$  TeV
- Bunch per 25 ns



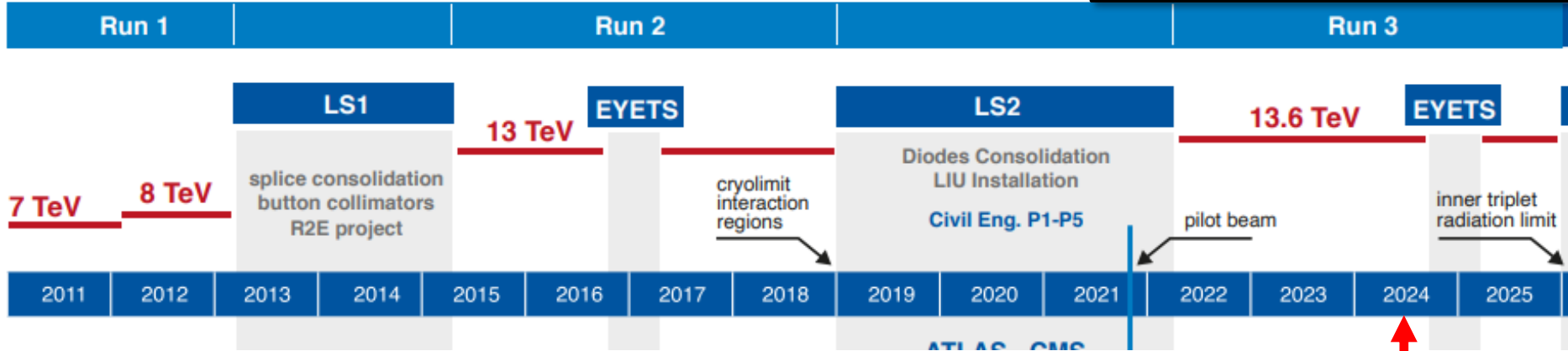
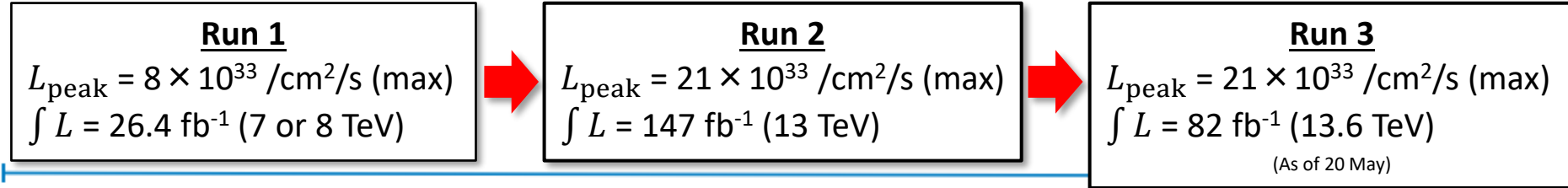
- ATLAS detector
  - Targets high- $p_T$  objects from decays of massive particles
  - Messy environment of  $pp$  collisions due to QCD
    - Track finding performance of ID is essential for all physics analyses
- Semiconductor Tracker (SCT): one component of ID

# SemiConductor Tracker (SCT)

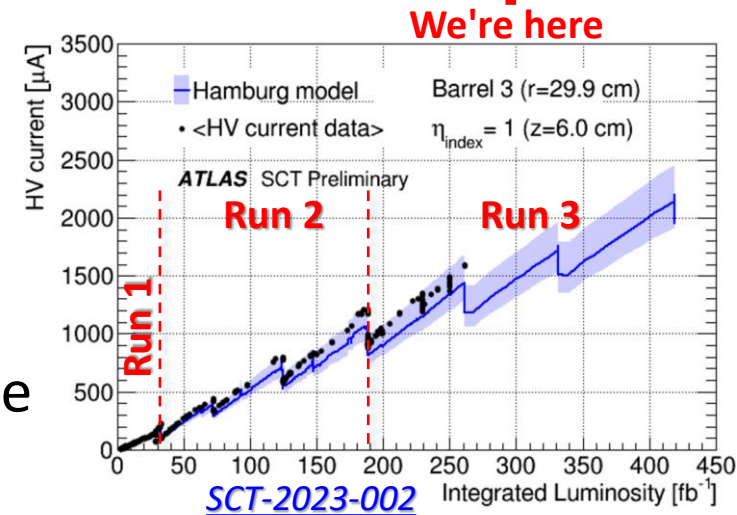


# Operation of SCT

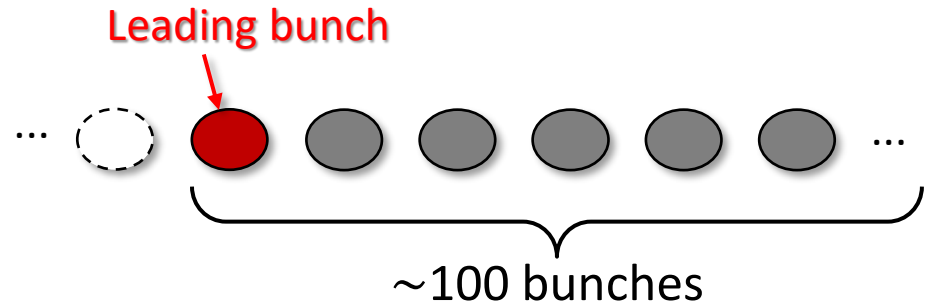
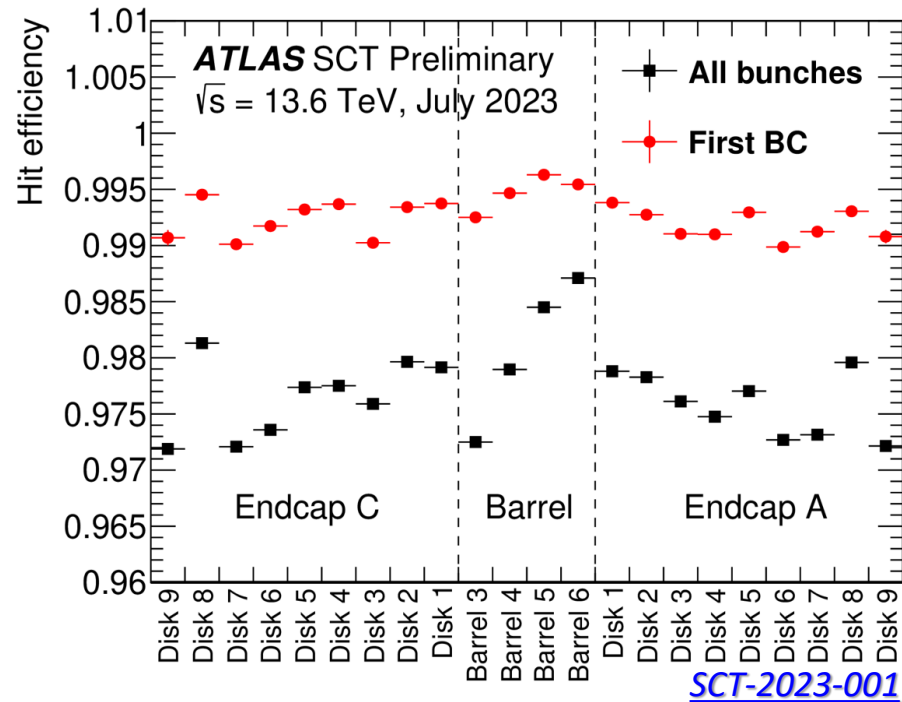
- SCT has been operated throughout data-taking



- LHC Run-3 operation is ongoing
  - Accumulation of radiation damage is significant; leakage current on the inner most layer reaches  $\sim 2 \text{ mA/module}$  (design: up to  $5 \text{ mA/module}$ )
- Understanding of the radiation damage is key for safe operation until 2025



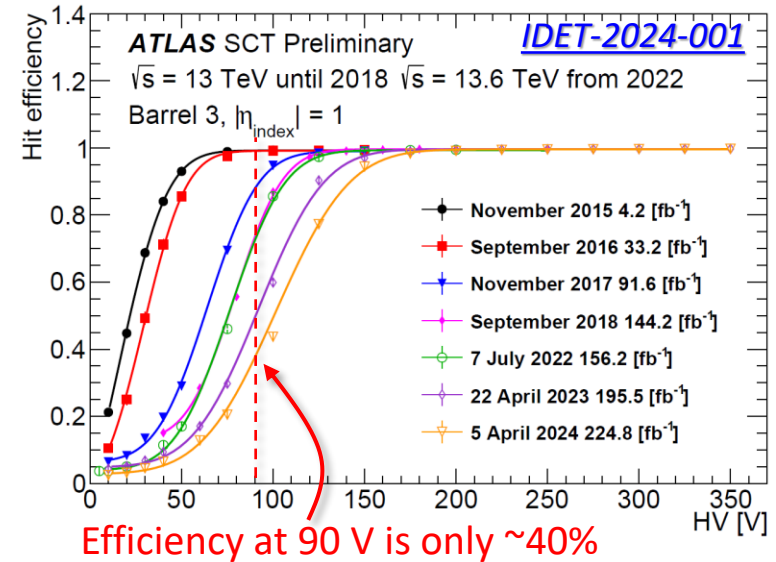
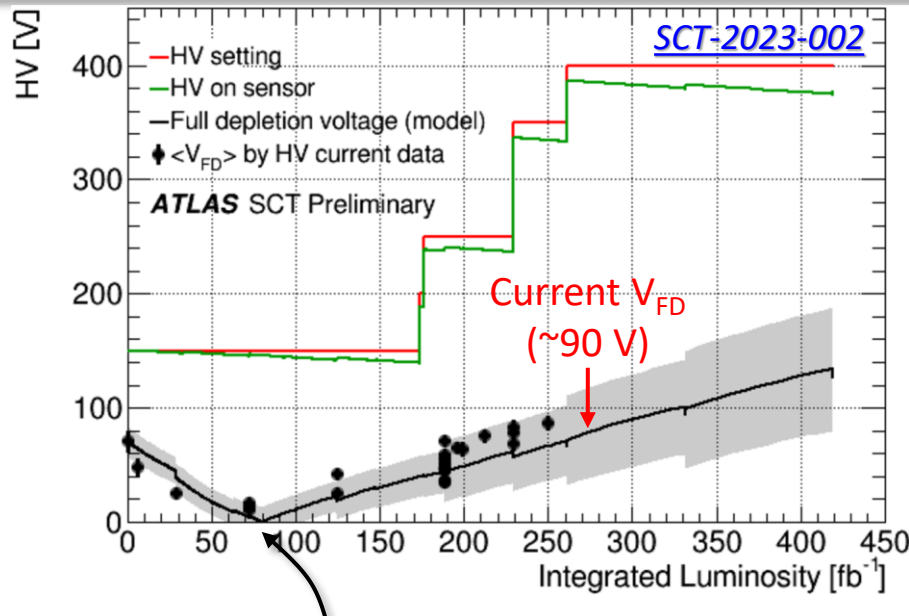
# Performance in Run 3



“No hit in the previous bunch” is required  
 → Overall efficiency loss around 1%  
 (negligible impact for tracking)

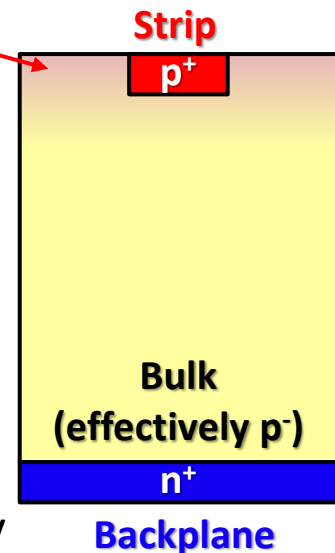
- Stable system has been already established in Run 2
  - 98% of the elements are active
  - Slight increase of problems in the backend electronics (no impact on data quality so far)
  - Intrinsic efficiency of > 99% is still maintained in Run 3; however we significantly increased the operation HV

# Full depletion voltage



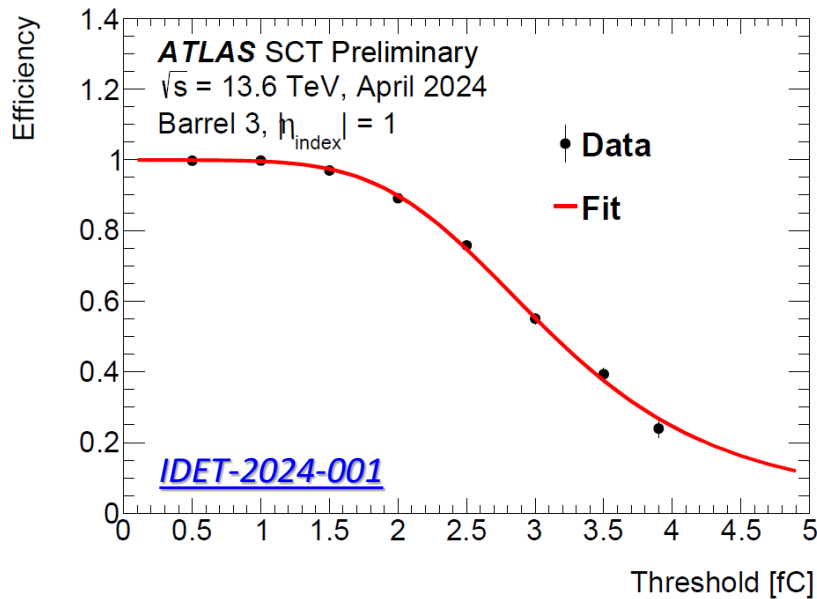
- Type inversion observed around 2017
  - pn junction on the rear side; need full depletion to efficiently collect charge
- Full depletion voltage ( $V_{FD}$ ) estimated from IV and efficiency vs HV
  - $V_{FD}$  from IV well agrees with the Hamburg model
  - However, need much higher HV required for 99% efficiency

E-field is strong on the surface



Good to understand the current charge collection efficiency (CCE)

# Charge collection efficiency



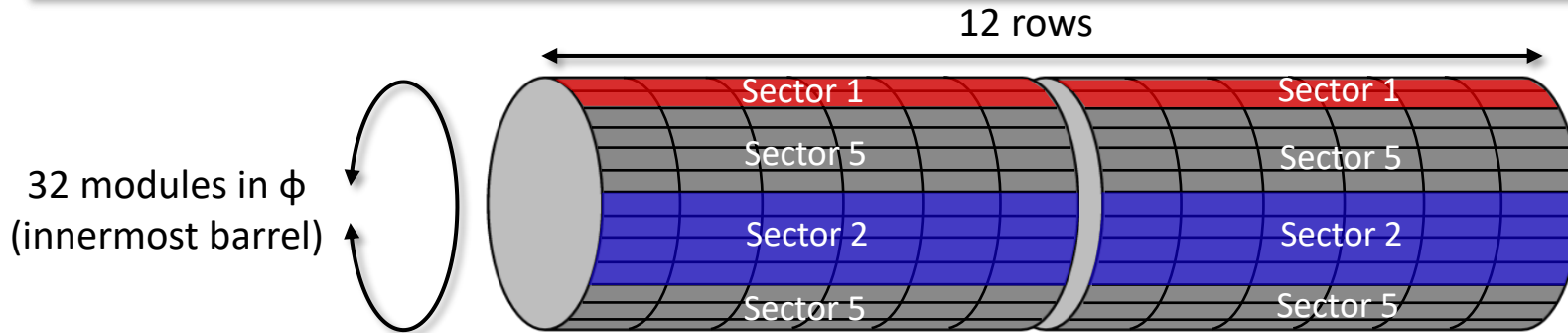
$$\epsilon(q) = p_1 [1 - \text{erf}(T f(T))]$$

$$\begin{cases} f(T) = 1 + 0.6 \tanh(-p_2 T) \\ T = \frac{(q - p_3)}{\sqrt{2} p_4} \end{cases}$$

$p_i$  ( $i = 1, 2, 3, 4$ ) are parameters determined by fit

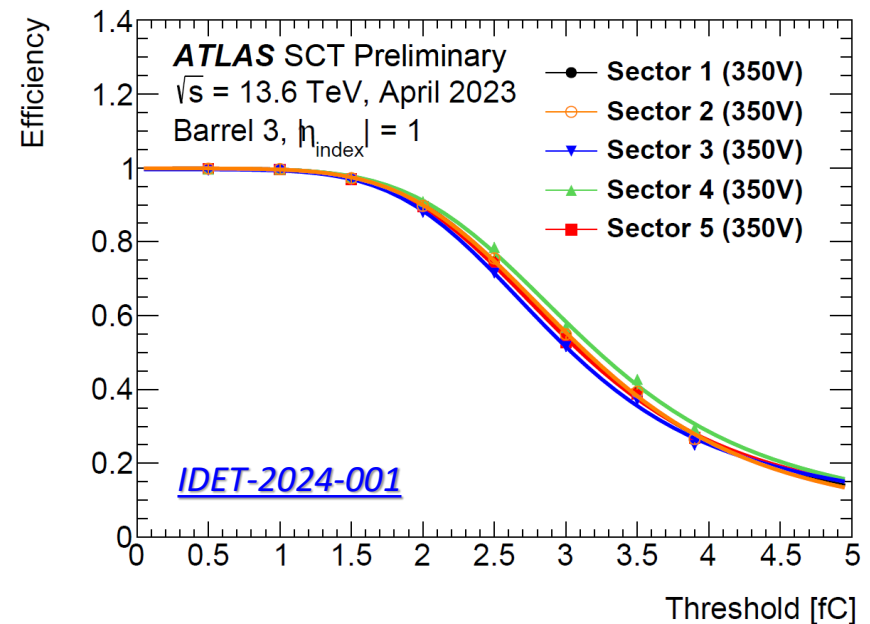
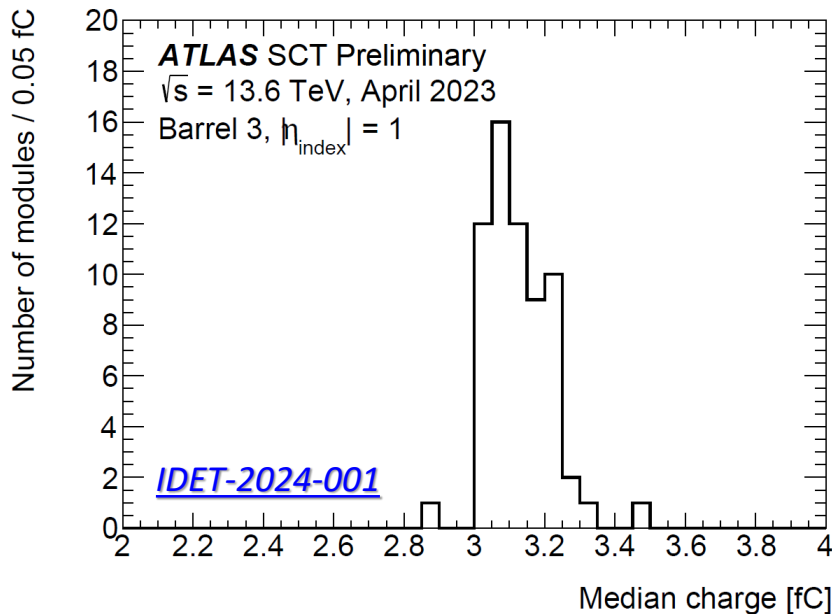
- SCT uses binary readout, so we cannot directly measure CCE
- However, median charge can be extracted by threshold scan
  - Perform a 'skewed' error function to account for the Landau distribution of charge
  - Median charge = threshold for 50% efficiency

# Strategy of the measurement



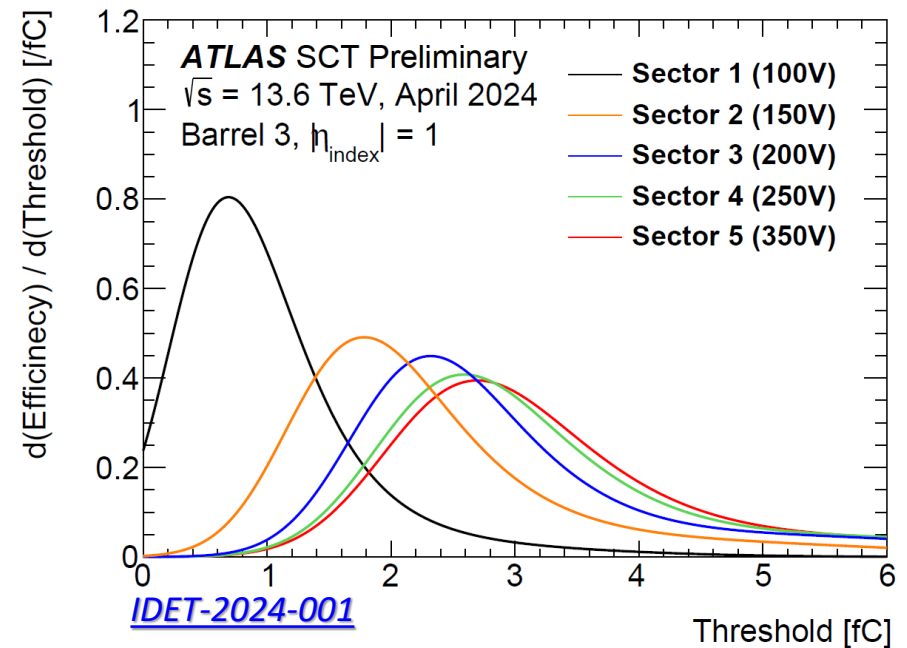
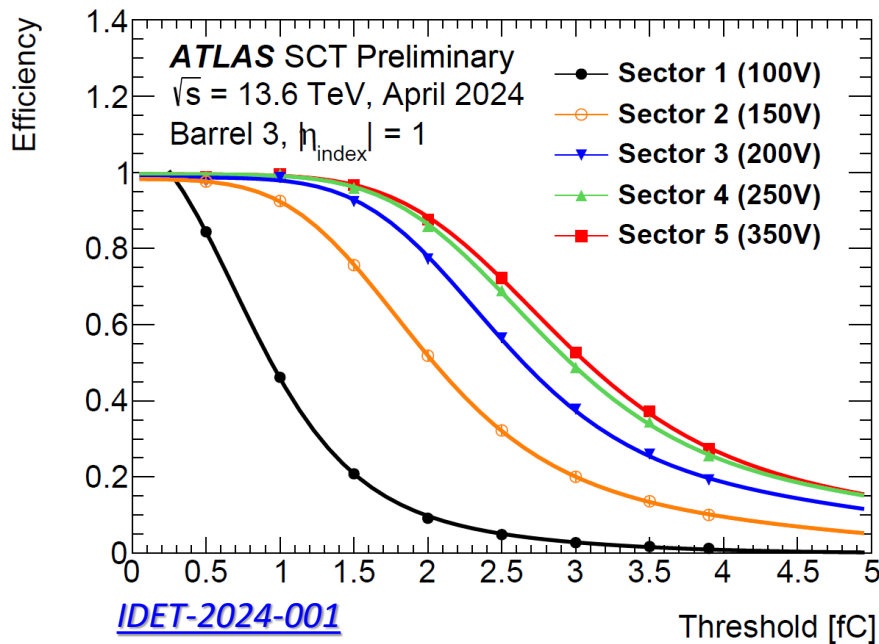
- Focus on innermost barrel
  - Most significant radiation damage: expected to be  $6.4 \times 10^{13} \text{ n}_{\text{eq}}/\text{cm}^2$
  - Select modules on the inner two rows closest to the IP; charged particles pass through in perpendicular to the sensor
    - There are  $32 \times 2 = 64$  modules usable
- Impossible to perform (threshold  $\times$  HV) scan
  - Too time consuming → Too large impact on physics data quality
- Divide the modules into 'octants' and set different HV
  - $\phi$  dependence of radiation damage is small
  - Four octants have different HV (Sectors 1-4)
  - Rest of octants have the operational HV: 350 V

# Validation of the strategy



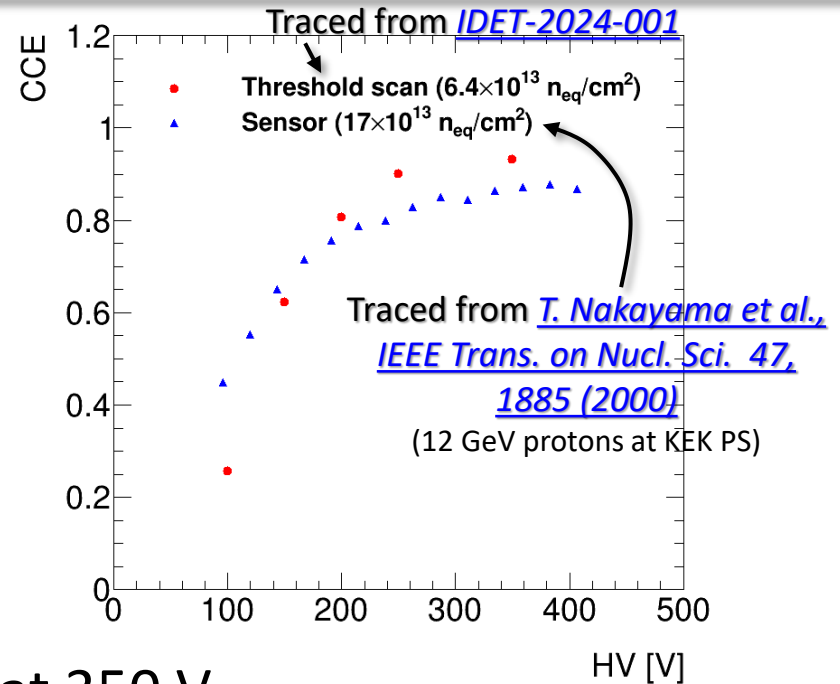
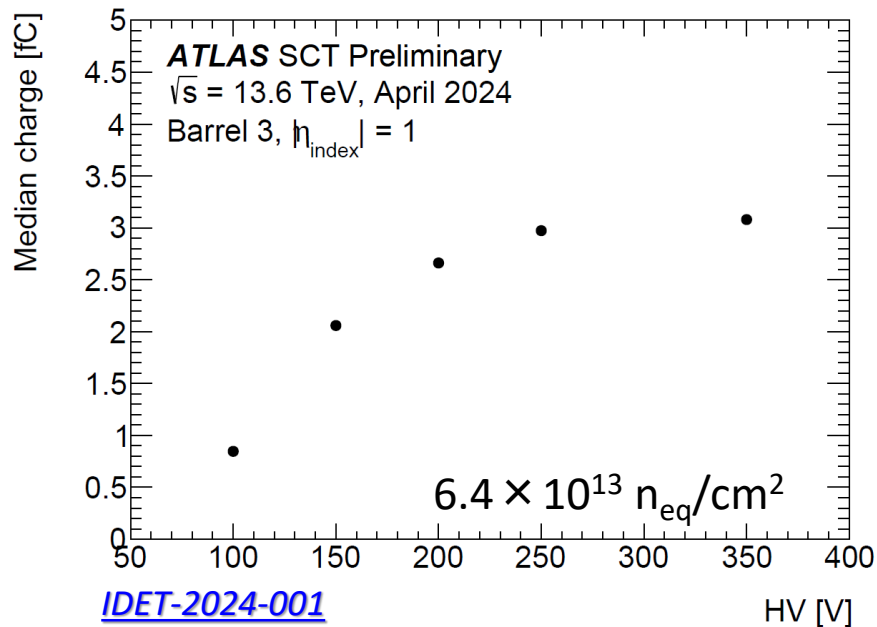
- Validation performed using the previous threshold scan data
  - All modules set at 350 V; consistent results are expected for all sectors
- Module-by-module measurement
  - Variation is  $\sim 3\%$  s.d.; sufficiently small
  - Two outliers  $\rightarrow$  Their impact is marginal once averaged by 8 modules
- Results from all the five sectors are very consistent!

# Threshold scan with different HV



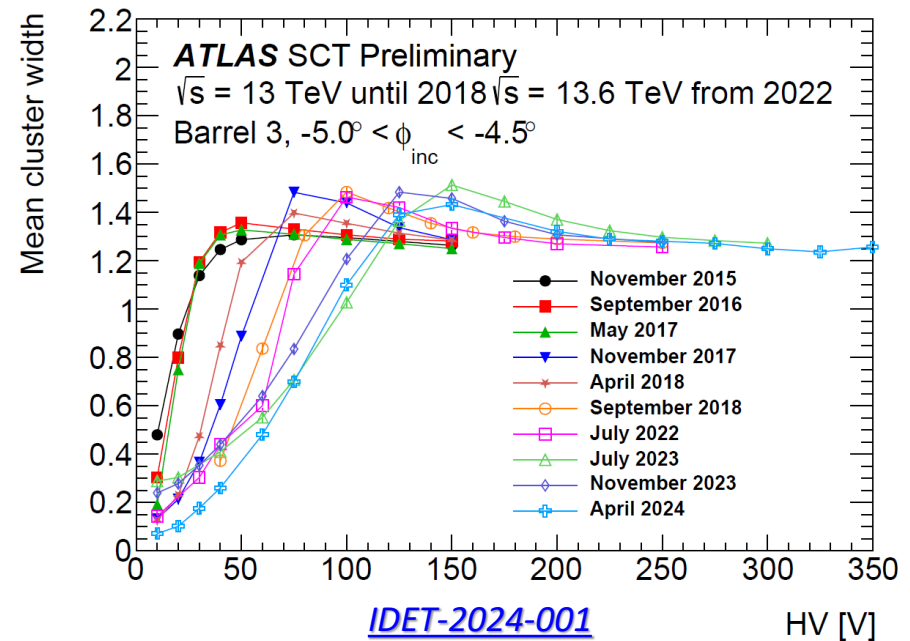
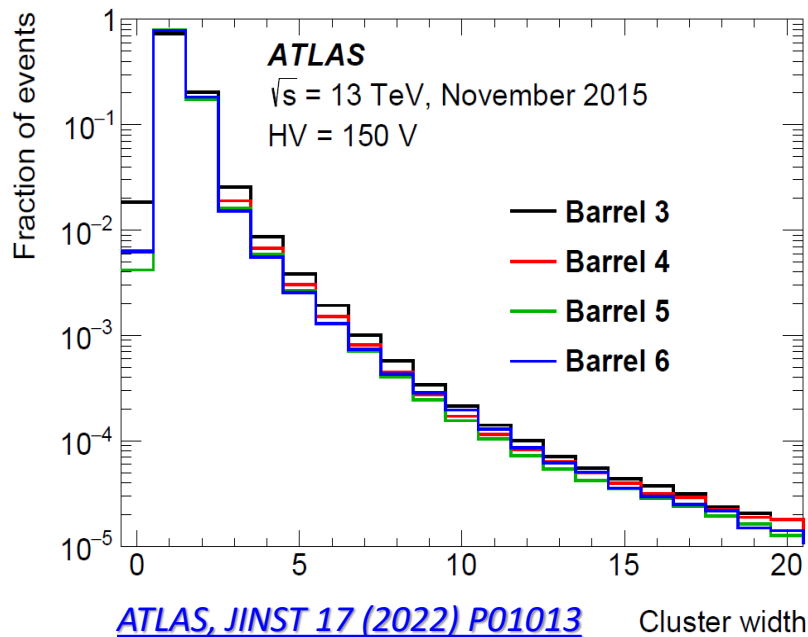
- Performed HV scan with different HV setting in April 2024
  - Set five HV points: 100 V, 150 V, 200 V, 250 V, 350 V (operation HV)
- Measurement successful
  - Derivatives of the fitted functions provide good estimate of the charge distribution
    - First time that we measured charge distribution of significantly irradiated sensors in the actual SCT detector!

# ■ CCE vs HV



- The plateau of the CCE is  $\sim 3$  fC at 350 V
  - SCT sensor is 285- $\mu\text{m}$  thick; 3.3 fC is expected without irradiation  
 $\rightarrow$  CCE  $\sim 90\%$
- Comparison with results from irradiated sensors
  - The CCE at plateau looks reasonable, but our result is significantly lower at low HV  $\rightarrow$  Need further investigation
  - N.B. charge leakage to the neighbouring strips may affect the CCE estimates

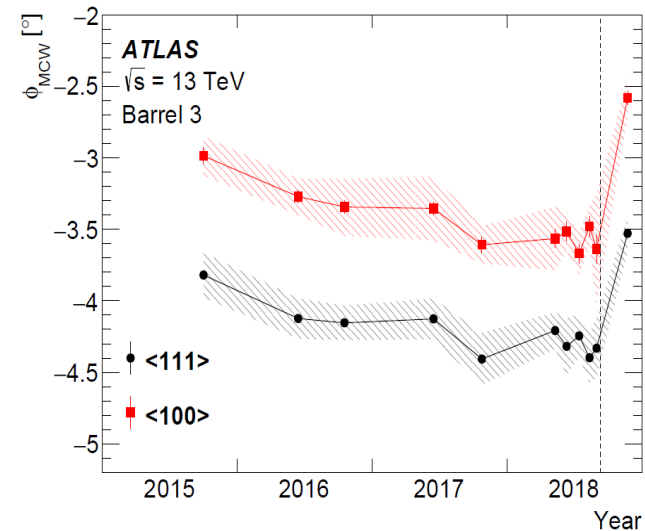
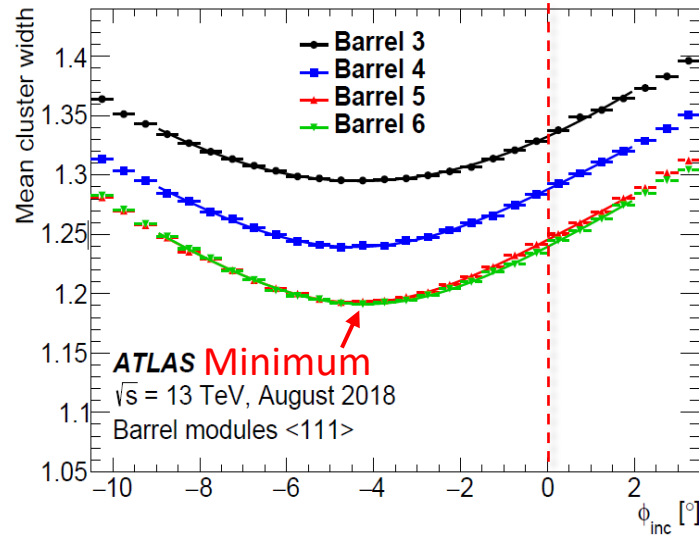
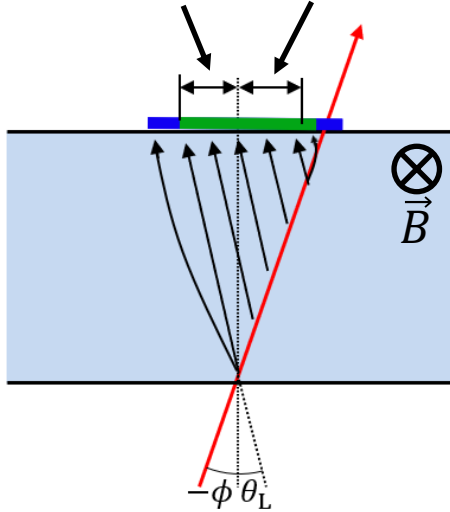
# Further studies: cluster size



- Cluster size is also a parameter reflecting the collected charge
  - Cluster = consecutive strips with a hit induced by a charged particle
  - Cluster size is typically 1, but can be  $\geq 2$  with  $\sim 30\%$  of the time
- HV dependence
  - A 'bump' appeared after type inversion
  - Maybe due to E-field shape near the surface, but exact reason not yet understood

# Lorentz angle

$$f(\phi) = a|L \tan \theta_L - L \tan \phi| \times G$$



[ATLAS, JINST 17 \(2022\) P01013](#)

- Charge motion is affected by the solenoid field
  - Charge is collected at the slightly deviated position
    - Incident angle ( $\phi_{inc}$ ) corresponding to the minimum cluster size is significantly shifted from  $0^\circ$
- Lorentz angle is affected by internal E-field
  - Reflects distortion in the E-field due to radiation damage
  - It is also affected by change of the operation HV

# ■ Summary

- SCT is operated since the beginning of LHC operation
  - Established stable DAQ system which can handle 2x higher luminosity than its original design
  - SCT is now under Run 3 operation while significantly irradiated
    - Stable operation required until the end of 2025 with understanding the irradiated detector
- Various studies are possible
  - Successfully measured CCE of the SCT for the first time using the radiation-damaged real SCT detector
  - Other key performance such as efficiency, cluster size, ...

● **Japan (H. Otono, S. Hirose et al.,)**

- Silicon detector operation
- Silicon sensor R&D

🇫🇷 **France Team (M. Bomben et al.,)**

- Silicon sensor simulation

Obtain knowledge from the 'real' detector

- Improve radiation models
- Extract useful information at the LHC environment towards HL-LHC